

UPC832, UPC4062

J-FET Input Low-Power Dual Operational Amplifiers

DESCRIPTION

UPC832, 4062 are J-FET input low-power operational amplifier featuring low supply voltage operation from ±2 V. Supply current is ten times smaller than that of UPC803, 4082 type op-amp. With very low input bias current characteristics, UPC832, 4062 are excellent choice for hand-held measurement equipment and other lowpower application circuits.

Depending on operating ambient temperature, UPC832 is suited for communication application while UPC4062 is for general purposes usage.

Along with this series of lineup, the quad type op-amp UPC834 and UPC4064 with same circuit configuration are also available.

FEATURES

| • | Input offset voltage | ±2 mV (TYP.) |
|---|------------------------------|---------------|
| • | Input bias current | 10 pA (TYP.) |
| • | Slew Rate | 3 V/µs (TYP.) |
| • | Unity Gain Frequency | 1 MHz (TYP.) |
| • | Circuit current | 400 μA (TYP.) |
| • | Low supply voltage operation | ±2 V |

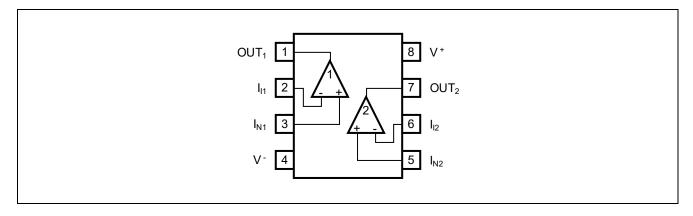
- Low supply voltage operation
- Build -in phase correction circuit
- Built-in output short-circuit protection circuit
- Standard dual op-amp terminal connection (pin compatible)

ORDERING INFORMATION

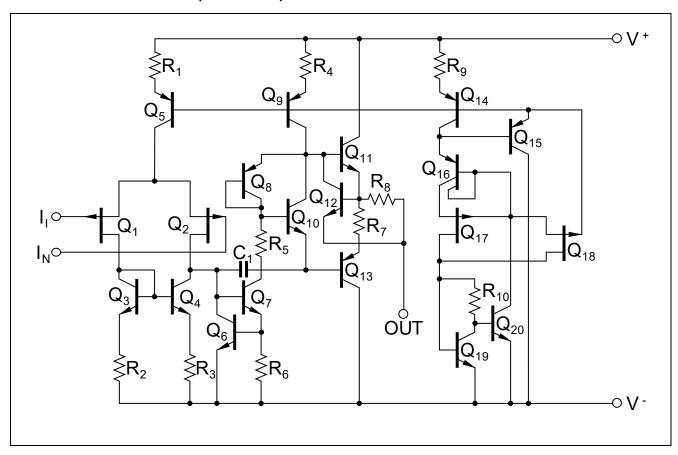
| Order Name ⁽¹⁾ | Package |
|---------------------------|--------------------------------------|
| UPC832G2-AP | 8-Pin plastic SOP (5.72 mm (225)) |
| UPC4062G2-AP | 8-Pin plastic SOP (5.72 mm (225)) |

(1) Order names containing E1 or E2 indicate that the packaging format is embossed taping. Pin 1 of E1 is on draw-out side, and pin 1 of E2 is at take-up side.

PIN CONFIGURATION (Top View)



EQUIVALENT CIRCUIT (1/2 Circuit)



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C)

| Parameter | Symbol | UPC832G2 | UPC4062G2 | Unit |
|---|--|-------------------|------------|------|
| Voltage between V ⁺ and V ⁻ Note1 V ⁺ - V ⁻ | | -0.3 | -0.3 ~ +36 | |
| Differential Input Voltage | V _{ID} | ±30 | | |
| Input Voltage Note 2 | Vı | V⁻ -0.3 ~ V⁺ +0.3 | | |
| Output applied Voltage Note3 | Vo | V0.3 ~ V++0.3 | | V |
| Total Power Dissipation Note4 | PT | 440 | | mW |
| Output Short Circuit Duration Note5 | | Indefinite | | |
| Operating Ambient Temperature | ng Ambient Temperature T_A $-40 \sim +85$ $-20 \sim +80$ | | -20 ~ +80 | °C |
| Storage Temperature | T _{stg} | -55 ~ +125 | | °C |

[Note] 1. Reverse connections of supply voltage can cause destruction.

- 2. The input voltage should be allowed to input without damage or destruction. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The normal operation will establish when the both inputs are within the Common Mode Input Voltage Range of electrical characteristics.
- 3. This specification is the voltage which should be allowed to supply to the output terminal from external without damage or destruction. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The output voltage of normal operation will be the Output Voltage Swing of electrical characteristics.
- **4.** Thermal derating factor is -4.4 mW/°C when operating ambient temperature is higher than 25 °C.
- **5.** Pay careful attention to the total power dissipation not to exceed the absolute maximum ratings and **Note 4**.

RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|---------------------------------------|---------------------|------|------|------|------|
| Supply Voltage | V [±] | ±2 | | ±16 | V |
| Output Source Current | lo source | | | 5 | mA |
| Output Sink Current | I _{O SINK} | | | 3.5 | mA |
| Capacitive Load (A _V = +1) | CL | | | 100 | pF |

ELECTRICAL CHARACTERISTICS (V = ±15 V, T_A = 25 °C)

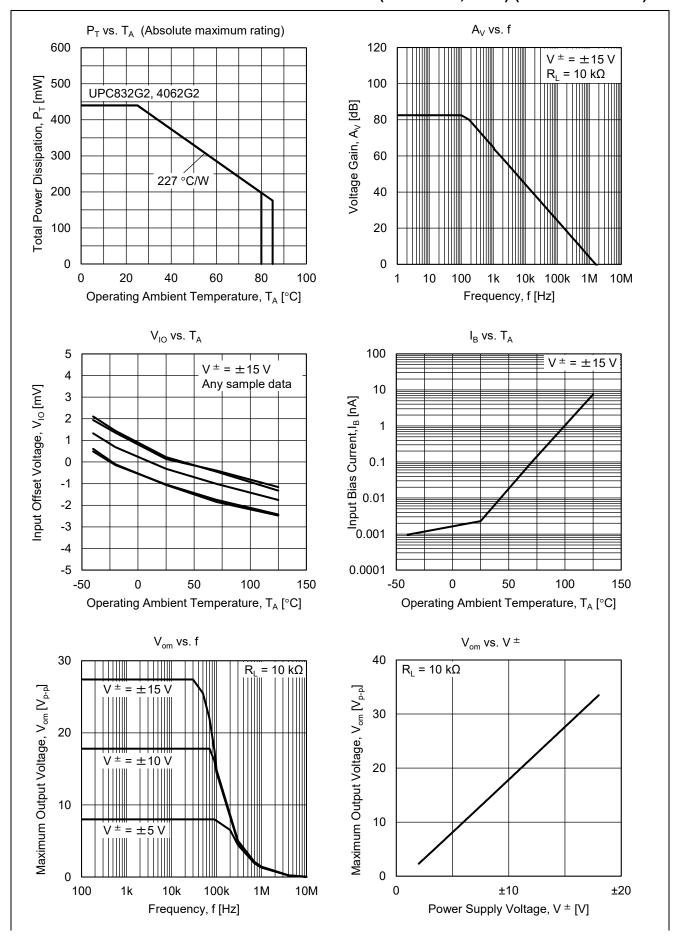
| Parameter | Symbol | MIN. | TYP. | MAX. | Unit | Conditions |
|--|--------------------------|------|----------------|------|--------|---|
| Input Offset Voltage | Vio | | ±2 | ±10 | mV | R _S ≤ 50 Ω |
| Input Offset Current Note6 | lio | | ±5 | ±50 | pА | |
| Input Bias Current Note6 | lΒ | | 10 | 100 | pА | |
| Large Signal Voltage Gain | Av | 3000 | 9000 | | | $R_L \ge 10 \text{ k}\Omega$, $V_O = \pm 10 \text{ V}$ |
| Supply Current Note7 | Icc | | 400 | 500 | μA | I _O = 0 A |
| Common Mode Rejection Ratio | CMR | 70 | 90 | | dB | |
| Supply Voltage Rejection Ratio | SVR | 70 | 90 | | dB | |
| Output Voltage Swing | V _{om} | ±12 | +14.0 -13.6 | | V | R _L ≥ 10 kΩ |
| Common Model Input Voltage Range | V _{ICM} | ±12 | +15 -13 | | V | |
| Slew Rate | SR | | 3 | | V/µs | A _V = 1 |
| Unity Gain Frequency | funity | | 1 | | MHz | |
| Input Equivalent Noise Voltage Density | en | | 30 | | nV/√Hz | $R_S = 100 \Omega$, $f = 1 \text{ kHz}$ |
| Channel Separation | | | 120 | | dB | |
| Input Offset Voltage | Vio | | | ±15 | mV | R _S ≤ 50 Ω, T _A = -20 ~ +70 °C |
| Average V _{IO} Temperature Drift | $\Delta V_{IO}/\Delta T$ | | ±10 | | μV/°C | T _A = -20 ~ +70 °C |
| Input Offset Current Note6 | lio | | | ±2 | nA | T _A = -20 ~ +70 °C |
| Input Bias Current Note6 | IB | | | 3.5 | nA | T _A = -20 ~ +70 °C |

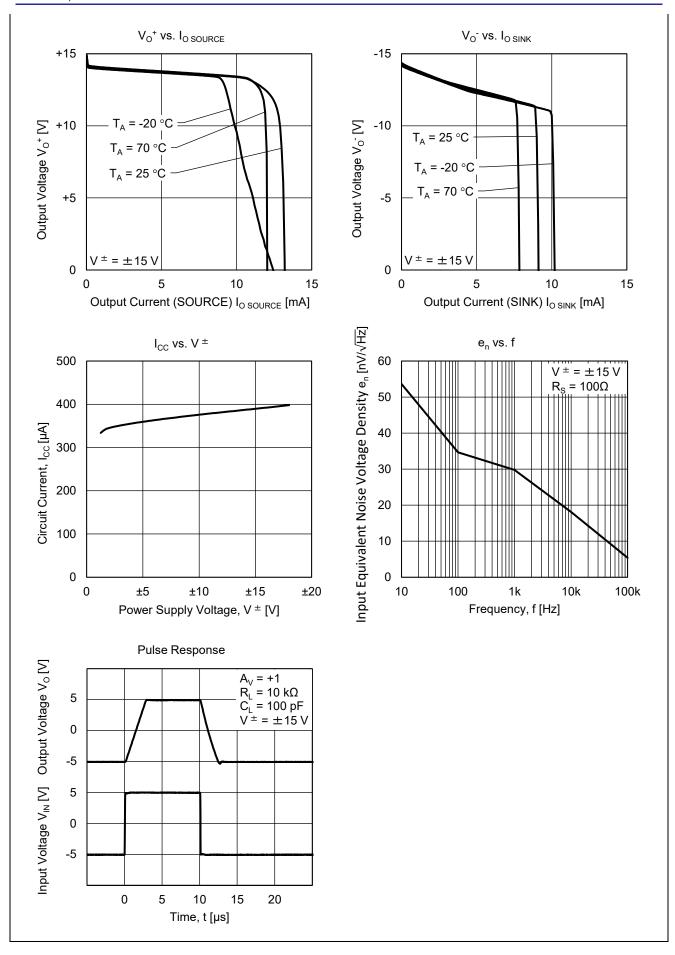
[[]Note] 6. Input bias currents flow into IC. Because each currents are gate leak current of P-channel J-FET on input stage. And that are temperature sensitive. Short time measuring method is recommendable to maintain the junction temperature close to the operating ambient temperature.

Note Since the UPC832 and UPC4062 have high input impedance characteristics, pay close attention to the isolation between the terminals on the board.

^{7.} This current flows irrespective of the existence of use.

TYPICAL PERFORMANCE CHARACTERISTICS (T_A = 25 °C, TYP.) (Reference value)



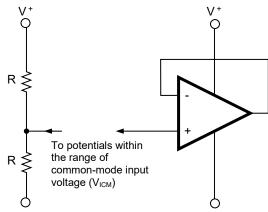


USE WITH PRECAUTIONS

· Managing unused circuits

If there is an unused circuit, the following connection is recommended.

Example of unused circuit process



Remark Note in this example, an intermediate voltage of V ⁺ and V ⁻ is applied.

• Power Supply (Dual Power Supply / Single Power Supply)

The op-amp operates as long as a predetermined voltage is applied between V^+ and V^- . Therefore, it can operate with a single power supply (V^- = GND), but it cannot operate the input and output near GND. Common-mode input voltage Please pay attention to the range and maximum output voltage.

· Ratings of input/output pin voltage

When the voltage of input/output pin exceeds the absolute maximum rating, the parasitic diode within the IC may conduct, causing characteristics degradation or damage. In addition, if the input pin is lower than V^- , or the output pin exceeds the power supply voltage, it is recommended to make a clamping circuit using a diode with low forward voltage (e.g.: Schottky diode) as protection.

· Range of common-mode input voltage

When the supply voltage does not meet the condition of electrical characteristics, the range of common-mode input voltage is as follows.

$$V_{ICM}$$
 (TYP.) : $V^- + 2 \sim V^+ [V]$ (T_A = 25 °C).

During designing, do include some tolerance by considering temperature characteristics etc.

· Maximum output voltage

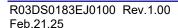
The TYP. value range of the maximum output voltage when the supply voltage does not meet the condition of electrical characteristics is as follows:

$$V_{om}^+$$
 (TYP.): $V^+ - 1$ [V] ($T_A = 25^{\circ}$ C), V_{om}^- (TYP.): $V^- + 1.4$ [V] ($T_A = 25^{\circ}$ C)

During designing, do include some tolerance by considering characteristics variation, temperature characteristics and so on. In addition, also note that the output voltage range $(V_{om}^+ - V_{om}^-)$ will become narrow when the output current increases.

· Handling of ICs

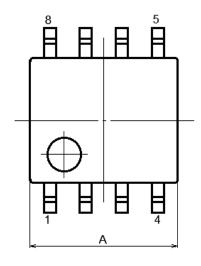
When stress is added to ICs due to warpage or bending of a board, the characteristic may fluctuates due to piezoelectric (piezo) effect. Therefore, pay attention to warpage or bending of a board.

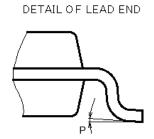


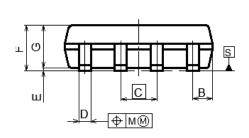
PACKAGE DRAWINGS

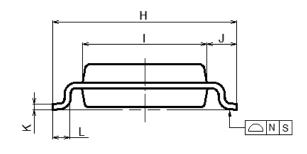
8-PIN PLASTIC SOP

| JEITA Package code | RENESAS code | MASS (TYP.) [g] |
|----------------------|--------------|-----------------|
| P-LSOP8-4.4×5.2-1.27 | PLSP0008DE-A | 0.09[g] |









NOTE
EACH LEAD CENTERLINE IS LOCATED WITHIN 0.12 MM OF
ITS TRUE POSITION(T.P.) AT MAXIMUM MATERIAL CONDITION.

| | (UNIT:mm) |
|------|------------|
| ITEM | DIMENSIONS |
| Α | 5.2±0.17 |
| В | 0.78MAX |
| С | 1.27(T.P) |
| D | 0.40±0.05 |
| Е | 0.1±0.1 |
| F | 1.59±0.21 |
| G | 1.49 |
| Н | 6.5±0.3 |
| | 4.4±0.1 |
| J | 1.05±0.15 |
| K | 0.2±0.07 |
| L | 0.6±0.20 |
| M | 0.1MAX |
| N | 0.1MAX |
| Р | 4°±4° |

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